# INTEGRATED CIRCUITS

# DATA SHEET

# **74LVT273** 3.3V Octal D flip-flop

Product specification
Supersedes data of 1994 May 11
IC23 Data Handbook





# 3.3V Octal D flip-flop

74LVT273

### **FEATURES**

- Eight edge-triggered D-type flip-flops
- Buffered common clock
- Buffered asynchronous Master Reset
- Output capability: +64mA/-32mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5V supply
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Power-up reset
- Live insertion/extraction permitted
- No bus current loading when output is tied to 5V bus
- Latchup protection exceeds 500 mA per JEDEC Std 17
- ESD protection exceeds 2000V per Mil Std 883 Method 3015 and 200V per Machine Model.

### **DESCRIPTION**

The LVT273 is a high-performance BiCMOS product designed for  $V_{CC}$  operation at 3.3V.

This device has eight edge-triggered D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) and Master Reset ( $\overline{MR}$ ) inputs load and reset (clear) all flip-flops simultaneously.

The register is fully edge-triggered. The state of each D input, one setup time before the Low-to-High clock transition, is transferred to the corresponding flip-flop's Q output.

All outputs will be forced Low independent of Clock or Data inputs by a Low voltage level on the  $\overline{\text{MR}}$  input. The device is useful for applications where the true output only is required and the CP and  $\overline{\text{MR}}$  are common elements.

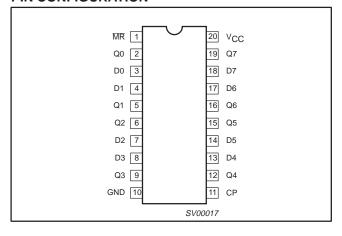
### **QUICK REFERENCE DATA**

| SYMBOL                               | PARAMETER                     | CONDITIONS<br>T <sub>amb</sub> = 25°C; GND = 0V | TYPICAL    | UNIT |
|--------------------------------------|-------------------------------|---|------------|------|
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation delay<br>CP to Qn | $C_L = 50pF; V_{CC} = 3.3V$                     | 3.5<br>3.5 | ns   |
| C <sub>IN</sub>                      | Input capacitance             | V <sub>I</sub> = 0V or 3.0V                     | 4          | pF   |

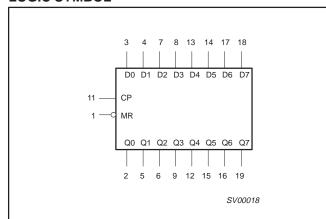
### **ORDERING INFORMATION**

| PACKAGES                    | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | DWG NUMBER |
|-----------------------------|-------------------|-----------------------|---------------|------------|
| 20-Pin Plastic SOL          | -40°C to +85°C    | 74LVT273 D            | 74LVT273 D    | SOT163-1   |
| 20-Pin Plastic SSOP Type II | -40°C to +85°C    | 74LVT273 DB           | 74LVT273 DB   | SOT339-1   |
| 20-Pin Plastic TSSOP Type I | -40°C to +85°C    | 74LVT273 PW           | 74LVT273PW DH | SOT360-1   |

### **PIN CONFIGURATION**



### **LOGIC SYMBOL**

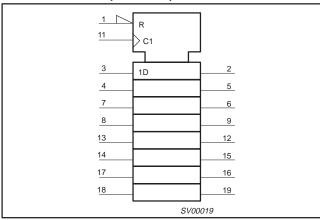


Product specification Philips Semiconductors

# 3.3V Octal D flip-flop

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### LOGIC SYMBOL (IEEE/IEC)



### **FUNCTION TABLE**

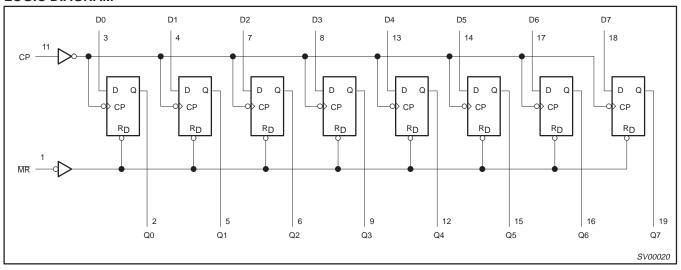
|    | INPUTS |                | OUTPUTS | OPERATING     |  |  |
|----|--------|----------------|---------|---------------|--|--|
| MR | СР     | D <sub>n</sub> | Q0 – Q7 | MODE          |  |  |
| L  | Х      | Х              | L       | Reset (clear) |  |  |
| Н  | 1      | h              | Н       | Load "1"      |  |  |
| Н  | 1      | I              | L       | Load "0"      |  |  |
| Н  | L      | Х              | $Q_0$   | Retain state  |  |  |

- H = High voltage level
  h = High voltage level one set-up time prior to the Low-to-High clock transition
- Low voltage level
   Low voltage level one set-up time prior to the Low-to-High clock transition
- = Don't care
- $\uparrow = \text{Low-to-High clock transition}$  $Q_0 = \text{Output as it was}$

### **PIN DESCRIPTION**

| PIN NUMBER                 | SYMBOL          | NAME AND FUNCTION                      |
|----------------------------|-----------------|--|
| 11                         | СР              | Clock pulse input (active rising edge) |
| 3, 4, 7, 8, 13, 14, 17, 18 | D0 – D7         | Data inputs                            |
| 2, 5, 6, 9, 12, 15, 16, 19 | Q0 – Q7         | Data outputs                           |
| 1                          | MR              | Master Reset input (active-Low)        |
| 10                         | GND             | Ground (0V)                            |
| 20                         | V <sub>CC</sub> | Positive supply voltage                |

### **LOGIC DIAGRAM**



# 3.3V Octal D flip-flop

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### **ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>**

| SYMBOL           | PARAMETER                      | CONDITIONS                  | RATING       | UNIT |
|------------------|--------------------------------|-----------------------------|--------------|------|
| V <sub>CC</sub>  | DC supply voltage              |                             | -0.5 to +4.6 | V    |
| I <sub>IK</sub>  | DC input diode current         | V <sub>I</sub> < 0          | -50          | mA   |
| V <sub>I</sub>   | DC input voltage <sup>3</sup>  |                             | -0.5 to +7.0 | V    |
| I <sub>OK</sub>  | DC output diode current        | V <sub>O</sub> < 0          | -50          | mA   |
| V <sub>OUT</sub> | DC output voltage <sup>3</sup> | output in Off or High state | -0.5 to +7.0 | V    |
|                  | DC output ourrent              | Output in Low state         | 128          | A    |
| Гоит             | DC output current              | Output in High State        | -64          | mA   |
| T <sub>stg</sub> | Storage temperature range      |                             | -65 to 150   | °C   |

### NOTES:

### **RECOMMENDED OPERATING CONDITIONS**

| SYMBOL           | PARAMETER   | LIM | UNIT |      |
|------------------|---|-----|------|------|
| STWIBOL          | PARAMETER   | MIN | MAX  | UNII |
| V <sub>CC</sub>  | DC supply voltage                                   | 2.7 | 3.6  | V    |
| VI               | Input voltage                                       | 0   | 5.5  | V    |
| V <sub>IH</sub>  | High-level input voltage                            | 2.0 |      | V    |
| V <sub>IL</sub>  | Low-level Input voltage                             |     | 0.8  | V    |
| I <sub>OH</sub>  | High-level output current                           |     | -32  | mA   |
| I <sub>OL</sub>  | Low-level output current                            |     | 64   | mA   |
| Δt/Δν            | Input transition rise or fall rate; Outputs enabled |     | 10   | ns/V |
| T <sub>amb</sub> | Operating free-air temperature range                | -40 | +85  | °C   |

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>2.</sup> The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

<sup>3.</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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### DC ELECTRICAL CHARACTERISTICS

|                   |  |   |                                      |                      |                      | LIMITS |    |  |  |
|-------------------|--|---|--------------------------------------|----------------------|----------------------|--------|----|--|--|
| SYMBOL            | PARAMETER  | TEST CONDITIONS   |                                      | Temp =               | UNIT                 |        |    |  |  |
|                   |  |   |                                      | MIN                  | TYP <sup>1</sup>     | MAX    |    |  |  |
| V <sub>IK</sub>   | Input clamp voltage  | $V_{CC} = 2.7V; I_{IK} = -18mA$   |                                      |                      | -0.9                 | -1.2   | V  |  |  |
|                   |  | $V_{CC} = 2.7 \text{ to } 3.6 \text{V}; I_{OH} = -100 \mu\text{A}$                |                                      | V <sub>CC</sub> -0.2 | V <sub>CC</sub> -0.1 |        |    |  |  |
| V <sub>OH</sub>   | High-level output voltage                                    | V <sub>CC</sub> = 2.7V; I <sub>OH</sub> = -8mA                                    |                                      | 2.4                  | 2.5                  |        | V  |  |  |
|                   |  | $V_{CC} = 3.0V; I_{OH} = -32mA$   |                                      | 2.0                  | 2.2                  |        |    |  |  |
|                   |  | $V_{CC} = 2.7V; I_{OL} = 100\mu A$  |                                      |                      | 0.1                  | 0.2    |    |  |  |
|                   |  | V <sub>CC</sub> = 2.7V; I <sub>OL</sub> = 24mA                                    |                                      |                      | 0.3                  | 0.5    |    |  |  |
| V <sub>OL</sub>   | Low-level output voltage                                     | V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 16mA                                    |                                      | 0.25                 | 0.4                  | V      |    |  |  |
|                   |  | V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 32mA                                    |                                      | 0.3                  | 0.5                  |        |    |  |  |
|                   |  | V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 64mA                                    |                                      | 0.4                  | 0.55                 |        |    |  |  |
| V <sub>RST</sub>  | Power-up output low voltage <sup>4</sup>                     | $V_{CC} = 3.6V$ ; $I_O = 1$ mA; $V_I = GND$ or $V_{CC}$                           | ;                                    |                      | 0.13                 | 0.55   | V  |  |  |
|                   |  | V <sub>CC</sub> = 0 or 3.6V; V <sub>I</sub> = 5.5V                                |                                      | 1                    | 10                   |        |    |  |  |
| <b>l</b> ,        | Land to the management                                       | $V_{CC} = 3.6V$ ; $V_I = V_{CC}$ or GND   | Control pins                         |                      | ±0.1                 | ±1     |    |  |  |
| l 1 <sub>1</sub>  | Input leakage current  | $V_{CC} = 3.6V; V_I = V_{CC}$   | Data pins <sup>3</sup>               |                      | 0.1                  | 1      | μΑ |  |  |
|                   |  | $V_{CC} = 3.6V; V_I = 0$  | Data piris                           |                      | -1                   | -5     |    |  |  |
| I <sub>OFF</sub>  | Output off current   | $V_{CC} = 0V; V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5V$                       |                                      |                      | 1                    | ±100   | μΑ |  |  |
|                   |  | $V_{CC} = 3V; V_I = 0.8V$   |                                      | 75                   | 150                  |        |    |  |  |
| I <sub>HOLD</sub> | Bus Hold current A inputs <sup>5</sup>                       | $V_{CC} = 3V; V_I = 2.0V$   |                                      | -75                  | -150                 |        | μΑ |  |  |
|                   |  | $V_{CC} = 0V \text{ to } 3.6V; V_{CC} = 3.6V$                                     | ±500                                 |                      |                      |        |    |  |  |
| I <sub>EX</sub>   | Current into an output in the High state when $V_O > V_{CC}$ | $V_O = 5.5V; V_{CC} = 3.0V$   |                                      |                      | 60                   | 125    | μΑ |  |  |
| I <sub>CCH</sub>  | Oution and autombut automate                                 | $V_{CC} = 3.6V$ ; Outputs High, $V_I = GND$ or                                    | V <sub>CC</sub> , I <sub>O</sub> = 0 |                      | 0.13                 | 0.19   |    |  |  |
| I <sub>CCL</sub>  | Quiescent supply current                                     | $V_{CC} = 3.6V$ ; Outputs Low, $V_I = GND$ or $V_{CC} = 0.6V$                     | $V_{CC}$ , $I_{O} = 0$               |                      | 3                    | 12     | mA |  |  |
| Δl <sub>CC</sub>  | Additional supply current per input pin <sup>2</sup>         | $V_{CC}$ = 3V to 3.6V; One input at $V_{CC}$ -0.6 Other inputs at $V_{CC}$ or GND | SV,                                  |                      | 0.1                  | 0.2    | mA |  |  |

### NOTES:

- All typical values are at V<sub>CC</sub> = 3.3V and T<sub>amb</sub> = 25°C.
   This is the increase in supply current for each input at the specified voltage level other than V<sub>CC</sub> or GND.
   Unused pins at V<sub>CC</sub> or GND.
- 4. For valid test results, data must not be loaded into the flip-flops (or latches) after applying the power.
- 5. This is the bus hold overdrive current required to force the input to the opposite logic state.

### **AC CHARACTERISTICS**

GND = 0V;  $t_R$  =  $t_F$  = 2.5ns;  $C_L$  = 50pF,  $R_L$  = 500 $\Omega$ ;  $T_{amb}$  = -40°C to +85°C.

| SYMBOL                               | PARAMETER                     | WAVEFORM | V <sub>C</sub> | c = 3.3V ±0      | .3V        | V <sub>CC</sub> = 2.7V | UNIT |
|--------------------------------------|-------------------------------|----------|----------------|------------------|------------|------------------------|------|
|                                      |                               |          | MIN            | TYP <sup>1</sup> | MAX        | MAX                    |      |
| f <sub>MAX</sub>                     | Maximum clock frequency       | 1        | 150            |                  |            |                        | MHz  |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation delay<br>CP to Qn | 1        | 1.7<br>1.9     | 3.5<br>3.5       | 5.5<br>5.5 | 6.3<br>5.9             | ns   |
| t <sub>PHL</sub>                     | Propagation delay MR to Qn    | 2        | 1.3            | 3.2              | 6.2        | 6.2                    | ns   |

<sup>1.</sup> All typical values are at  $V_{CC}$  = 3.3V and  $T_{amb}$  = 25°C.

# 3.3V Octal D flip-flop

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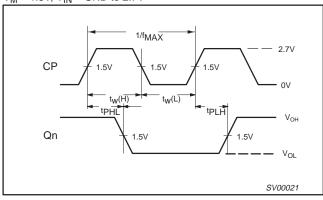
### **AC SETUP REQUIREMENTS**

GND = 0V;  $t_R = t_F = 2.5 ns$ ;  $C_L = 50 pF$ ,  $R_L = 50 0\Omega$ ,  $T_{amb} = -40 ^{\circ} C$  to +85  $^{\circ} C$ .

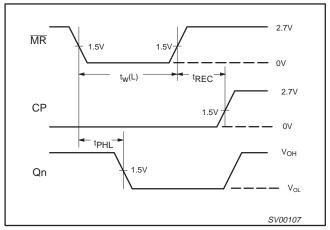
| SYMBOL                                   | PARAMETER                           | WAVEFORM | V <sub>CC</sub> = +3 | .3 ± 0.3V    | V <sub>CC</sub> = 2.7V | UNIT |
|--|-------------------------------------|----------|----------------------|--------------|------------------------|------|
|  |                                     |          | MIN                  | TYP          | MIN                    |      |
| t <sub>s</sub> (H)<br>t <sub>s</sub> (L) | Setup time, High or Low<br>Dn to CP | 3        | 2.3<br>2.3           | 1.0<br>1.0   | 2.7<br>2.7             | ns   |
| t <sub>h</sub> (H)<br>t <sub>h</sub> (L) | Hold time, High or Low<br>Dn to CP  | 3        | 0<br>0               | -0.6<br>-0.6 | 0<br>0                 | ns   |
| t <sub>w</sub> (H)<br>t <sub>w</sub> (L) | Clock pulse width<br>High or Low    | 1        | 3.3<br>3.3           | 1.5<br>1.5   | 3.3<br>3.3             | ns   |
| t <sub>w</sub> (L)                       | Master Reset pulse width, Low       | 2        | 3.3                  | 1.5          | 3.3                    | ns   |
| t <sub>REC</sub>                         | Recovery time MR to CP              | 2        | 2.7                  | 1.0          | 3.2                    | ns   |

### **AC WAVEFORMS**

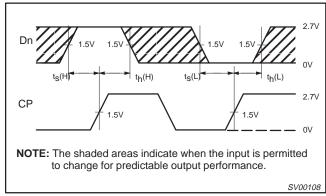
 $V_M$  = 1.5V,  $V_{IN}$  = GND to 2.7V



Waveform 1. Propagation Delay, Clock Input to Output, Clock Pulse Width, and Maximum Clock Frequency



Waveform 2. Master Reset Pulse Width, Master Reset to Output Delay and Master Reset to Clock Recovery Time

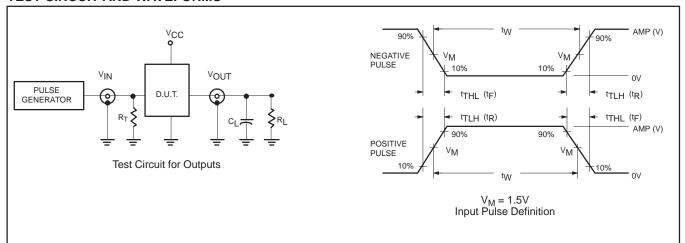


Waveform 3. Data Setup and Hold Times

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### **TEST CIRCUIT AND WAVEFORMS**



### **DEFINITIONS**

 $R_L$  = Load resistor; see AC CHARACTERISTICS for value.

 $C_L = Load$  capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

| FAMILY  | INPUT PULSE REQUIREMENTS |           |                |                |                |  |  |  |  |
|---------|--------------------------|-----------|----------------|----------------|----------------|--|--|--|--|
| FAIVILI | Amplitude                | Rep. Rate | t <sub>W</sub> | t <sub>R</sub> | t <sub>F</sub> |  |  |  |  |
| 74LVT   | 2.7V                     | ≤10MHz    | 500ns          | ≤2.5ns         | ≤2.5ns         |  |  |  |  |

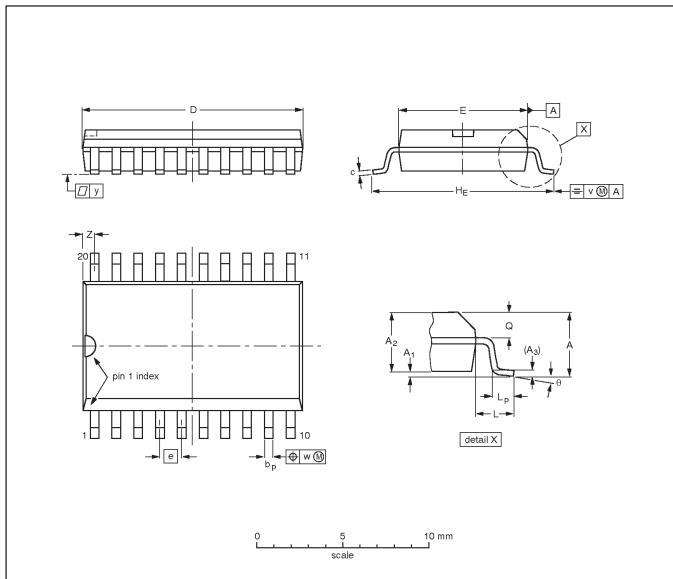
SV00022

# 3.3V Octal D flip-flop

74LVT273

### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT   | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | А3   | bp             | O              | D <sup>(1)</sup> | E <sup>(1)</sup> | e     | HE             | ٦     | Lp             | Q          | ٧    | w    | у     | z <sup>(1)</sup> | θ  |
|--------|-----------|----------------|----------------|------|----------------|----------------|------------------|------------------|-------|----------------|-------|----------------|------------|------|------|-------|------------------|----|
| mm     | 2.65      | 0.30<br>0.10   | 2.45<br>2.25   | 0.25 | 0.49<br>0.36   | 0.32<br>0.23   | 13.0<br>12.6     | 7.6<br>7.4       | 1.27  | 10.65<br>10.00 | 1.4   | 1.1<br>0.4     | 1.1<br>1.0 | 0.25 | 0.25 | 0.1   | 0.9<br>0.4       | 8° |
| inches | 0.10      | 0.012<br>0.004 | 0.096<br>0.089 | 0.01 | 0.019<br>0.014 | 0.013<br>0.009 | 0.51<br>0.49     | 0.30<br>0.29     | 0.050 | 0.419<br>0.394 | 0.055 | 0.043<br>0.016 |            | 0.01 | 0.01 | 0.004 | 0.035<br>0.016   | 0° |

### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

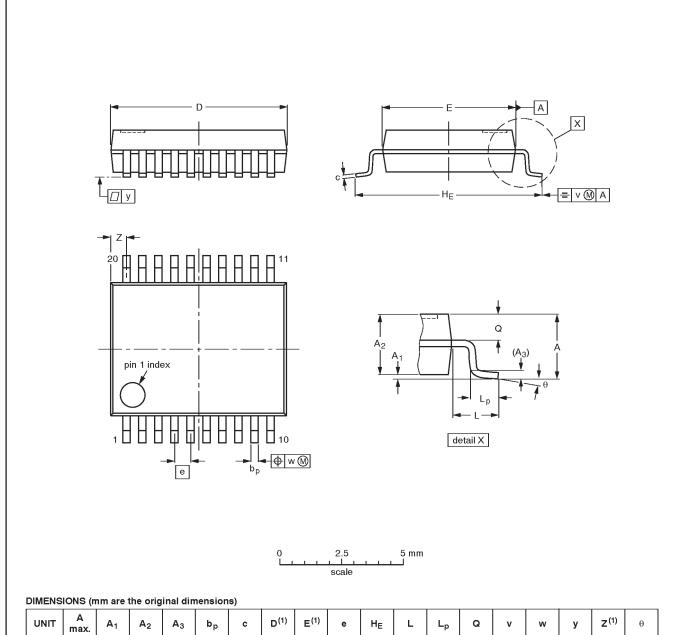
| OUTLINE  |        | REFER    | EUROPEAN | ISSUE DATE |            |                                  |
|----------|--------|----------|----------|------------|------------|----------------------------------|
| VERSION  | IEC    | JEDEC    | EIAJ     |            | PROJECTION | ISSUE DATE                       |
| SOT163-1 | 075E04 | MS-013AC |          |            |            | <del>-95-01-24</del><br>97-05-22 |

# 3.3V Octal D flip-flop

74LVT273

### SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



| UNIT | A<br>max. | Α1           | A <sub>2</sub> | А3   | bр           | С            | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | HE         | L    | Lp           | Q          | v   | w    | у   | Z <sup>(1)</sup> | θ        |
|------|-----------|--------------|----------------|------|--------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm   | 2.0       | 0.21<br>0.05 | 1.80<br>1.65   | 0.25 | 0.38<br>0.25 | 0.20<br>0.09 | 7.4<br>7.0       | 5.4<br>5.2       | 0.65 | 7.9<br>7.6 | 1.25 | 1.03<br>0.63 | 0.9<br>0.7 | 0.2 | 0.13 | 0.1 | 0.9<br>0.5       | 8°<br>0° |

### Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

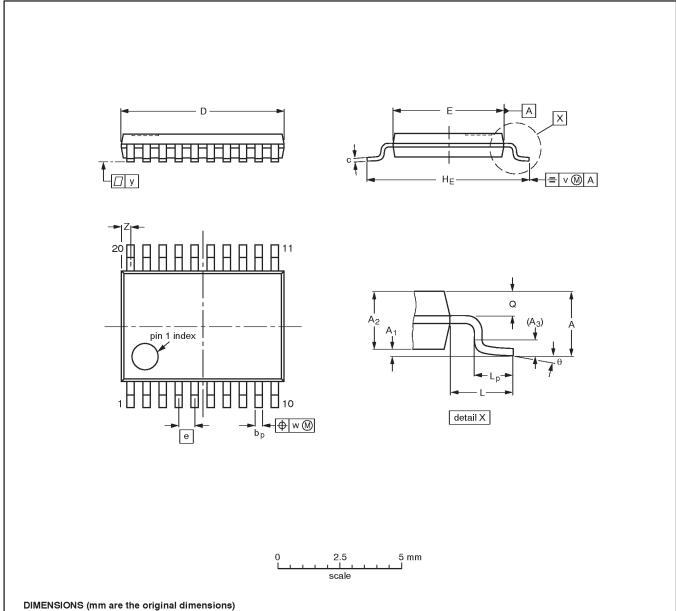
| OUTLINE  |     | REFER    | RENCES | EUROPEAN   | ISSUE DATE                      |
|----------|-----|----------|--------|------------|---------------------------------|
| VERSION  | IEC | JEDEC    | EIAJ   | PROJECTION | ISSUE DATE                      |
| SOT339-1 |     | MO-150AE |        |            | <del>93-09-08</del><br>95-02-04 |

# 3.3V Octal D flip-flop

74LVT273

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



|      |           |              |                |                       |              | -,         |                  |                  |      |            |     |              |            |     |      |     |                  |          |
|------|-----------|--------------|----------------|-----------------------|--------------|------------|------------------|------------------|------|------------|-----|--------------|------------|-----|------|-----|------------------|----------|
| UNIT | A<br>max. | Α1           | A <sub>2</sub> | <b>A</b> <sub>3</sub> | bp           | С          | D <sup>(1)</sup> | E <sup>(2)</sup> | е    | HE         | L   | Lp           | Q          | v   | w    | у   | Z <sup>(1)</sup> | θ        |
| mm   | 1.10      | 0.15<br>0.05 | 0.95<br>0.80   | 0.25                  | 0.30<br>0.19 | 0.2<br>0.1 | 6.6<br>6.4       | 4.5<br>4.3       | 0.65 | 6.6<br>6.2 | 1.0 | 0.75<br>0.50 | 0.4<br>0.3 | 0.2 | 0.13 | 0.1 | 0.5<br>0.2       | 8°<br>0° |

### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE  |     | REFER    | RENCES | EUROPEAN   | ISSUE DATE                        |
|----------|-----|----------|--------|------------|-----------------------------------|
| VERSION  | IEC | JEDEC    | EIAJ   | PROJECTION | ISSUEDATE                         |
| SOT360-1 |     | MO-153AC |        |            | <del>-93-06-16-</del><br>95-02-04 |

## 3.3V Octal D flip-flop

74LVT273

### Data sheet status

| Data sheet status         | Product<br>status | Definition [1]  |
|---------------------------|-------------------|---|
| Objective specification   | Development       | This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.   |
| Preliminary specification | Qualification     | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product. |
| Product specification     | Production        | This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.  |

<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

### **Definitions**

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Application information** — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

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